Schottky Barrier Diode

DB2J31700L

### **Panasonic**

### DB2J31700L

### Silicon epitaxial planar type

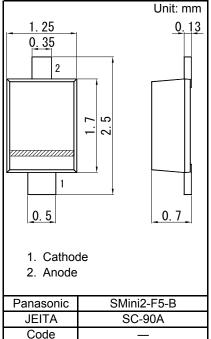
#### For rectification

#### ■ Features

- Low forward voltage VF
- Forward current (Average) IF(AV) = 1 A rectification is possible
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: 3S

#### ■ Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

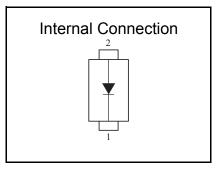


Panasonic	SMini2-F5-B
JEITA	SC-90A
Code	_

#### ■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit			
Reverse voltage (direct current)	VR	30	V			
Forward current (average) *1	IF(AV)	1	Α			
Non-repetitive peak forward surge current *2	IFSM	3	Α			
Junction temperature	Tj	125	°C			
Operating ambient temperature	Topr	-40 to +85	°C			
Storage temperature	Tstg	-55 to +125	°C			

Note: \*1 For embedded alumina substrate (substrate size: 5 cm× 5 cm)



<sup>\*2 50</sup> Hz sine wave 1 cycle (Non-repetitive peak current)

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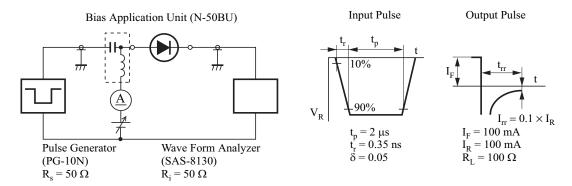
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### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

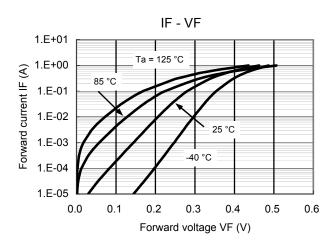
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF1	IF = 700 mA		0.41	0.48	V
	VF2	IF = 1A		0.46	0.52	V
Reverse current	IR	VR = 30 V		10	100	μA
Terminal capacitance	Ct	VR = 10 V, f = 1 MHz		22		pF
Reverse recovery time *1	trr	IF = IR = 100 mA		7.8		ns
		Irr = $0.1 \times IR$ , RL = $100 \Omega$	1.0		1.13	

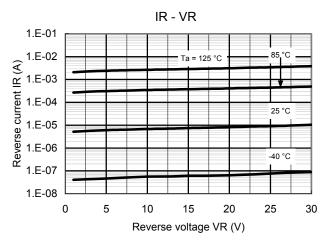
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
  - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 3. \*1 trr test circuit

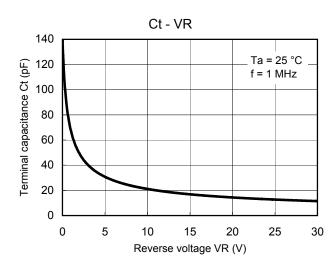


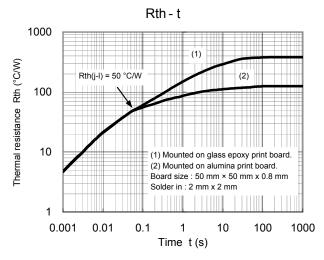
# **Panasonic**

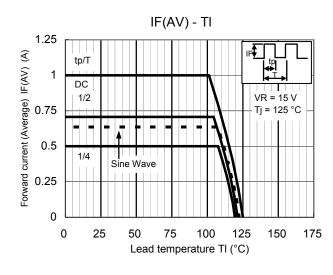
### Technical Data (reference)

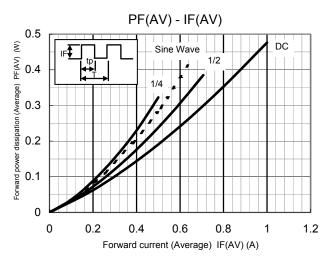








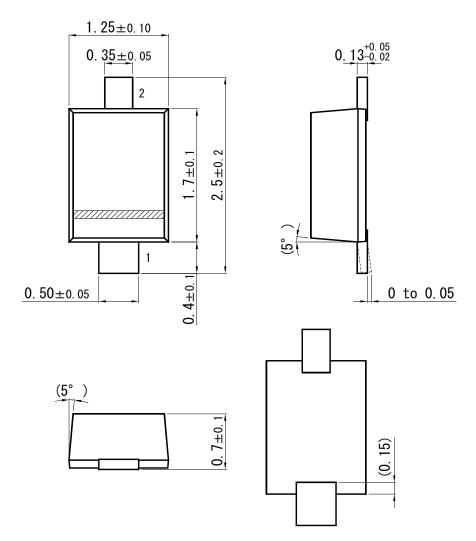




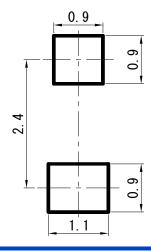
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SMini2-F5-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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